

SID

Factory: Rot am See

Article:

517

ML6

Provided:

Kracht, Enrico

Customer:

Date:

10.08.2015



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	123		2	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		3	
		35	L2		
A-RS-FR4-ML-0.20mm-035+035-TG150-HF	50200653	200		4	A01
		35	L3		
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	105		5	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		6	
		35	L4		
A-RS-FR4-ML-0.20mm-035+035-TG150-HF	50200653	200		7	A02
		35	L5		
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	123		8	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		9	
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	10	

B00:

Thickness after Pressing

B00:

940 µm

Tol+:

105 µm

Tol-:

105 µm

Dmax:

1045 µm

Dmin:

835 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

1050 µm

Tol+:

105 µm

Tol-:

105 µm

Dmax:

1155 µm

Dmin:

945 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

927 µm

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